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RESPONSE UNDER 37 CFR 1.116
EXPEDITED PROCEDURE

IN THE U.S. PATENT AND TRADEMARK OFFICE

January 15, 2009

Applicants: Atsushi YABE et al
For: ELECTROLESS COPPER PLATING SOLUTION
Serial No.: 10/576 231 Group: 1792
Confirmation No.: 7188
Filed: April 14, 2006 Examiner: Bareford
International Application No.: PCT/JP2004/011327
International Filing Date: July 30, 2004
Atty. Docket No.: 4700.P0327US
Mail Stop AF
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

REQUEST FOR RECONSIDERATION

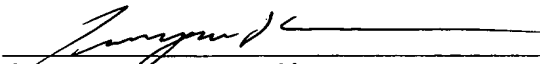
Sir:

In response to the Office Action dated October 20, 2008,
Applicants respectfully request reconsideration.

(Please see the following pages.)

CERTIFICATE OF MAILING

I hereby certify that this correspondence is being
deposited with the United States Postal Service as first class
mail in an envelope addressed to: Assistant Commissioner for
Patents, Washington, DC 20231 on January 15, 2009.


Terryence F. Chapman